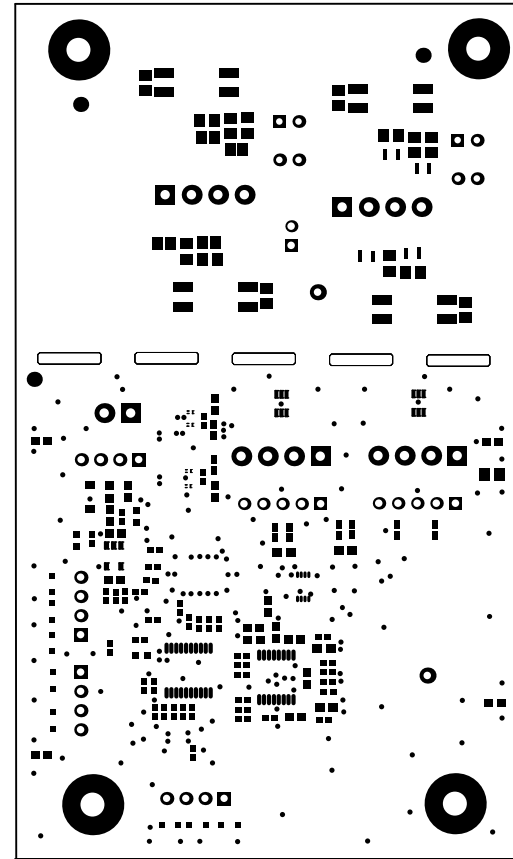
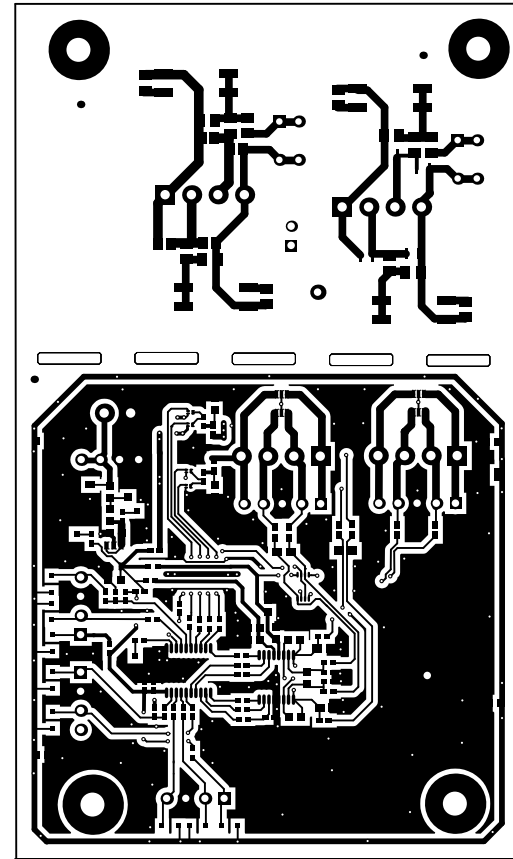


H5 H8

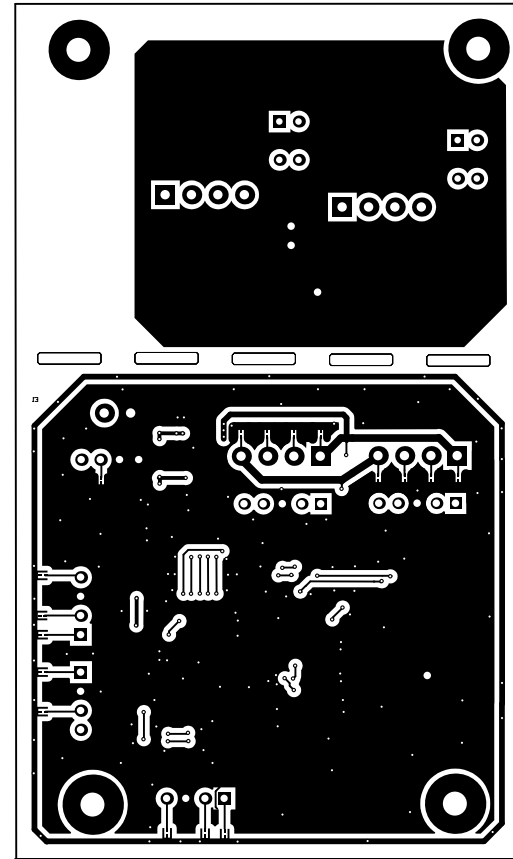
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:44 PM	TEXAS INSTRUMENTS	



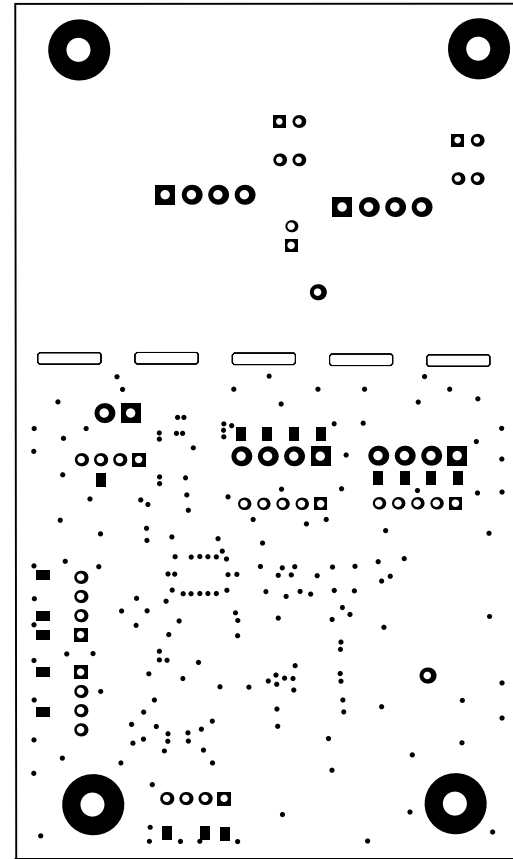
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:45 PM	TEXAS INSTRUMENTS	



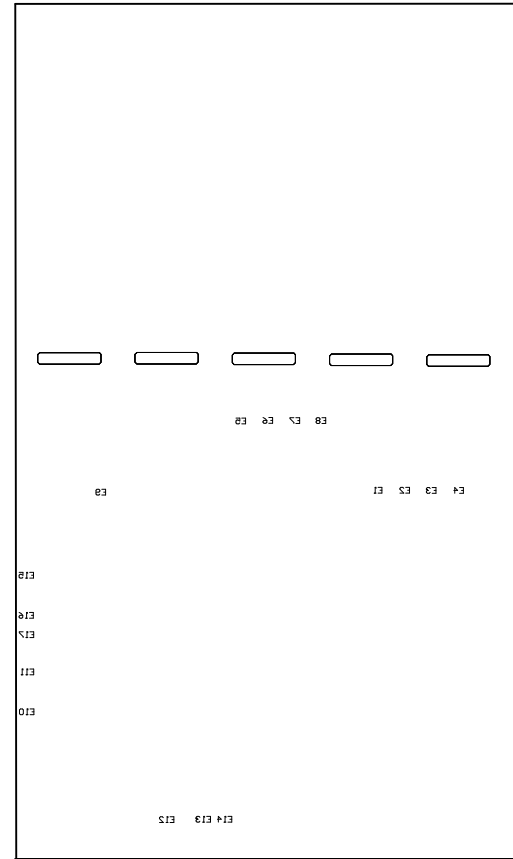
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:46 PM	TEXAS INSTRUMENTS	



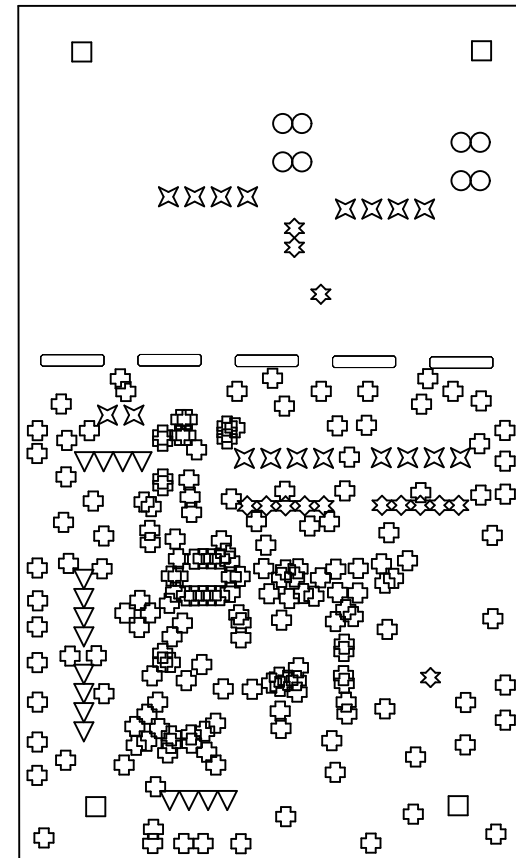
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:47 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:49 PM	TEXAS INSTRUMENTS	

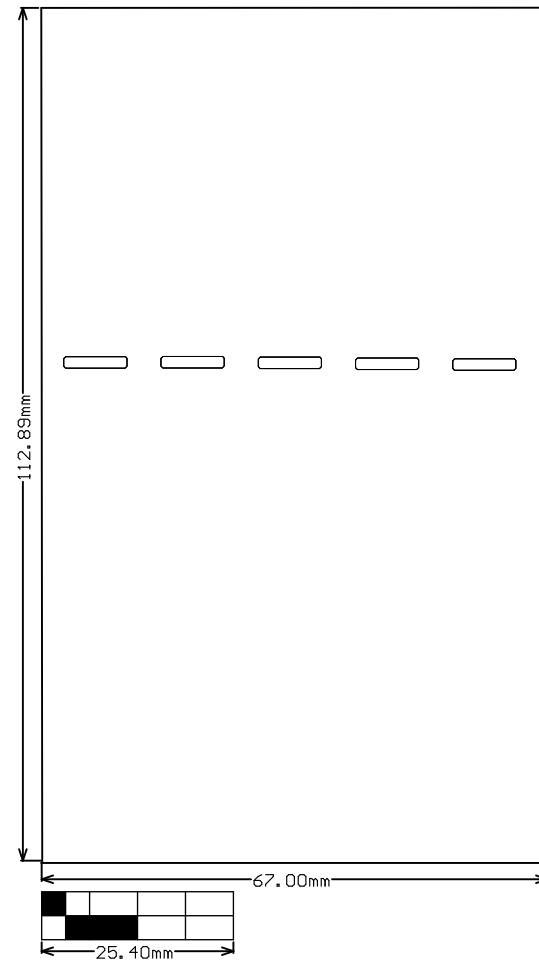


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:50 PM	TEXAS INSTRUMENTS	



Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊕	163	12.00mil (0.305mm)	PTH	Round
○	8	35.00mil (0.889mm)	PTH	Round
▽	16	39.37mil (1.000mm)	PTH	Round
☆	14	40.00mil (1.016mm)	PTH	Round
✱	18	50.00mil (1.270mm)	PTH	Round
□	4	125.98mil (3.200mm)	PTH	Round
	243 Total			

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:51 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00765	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: TIDA-00765		
PLOT NAME =	GENERATED : 3/24/2016 5:08:52 PM	TEXAS INSTRUMENTS	

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